1	2	3	Edited by Foxit PDF Editor Copyright (c) by Foxit Software Company, 2003 - 2009 For Evaluation Only.
Testing/ Solder-Ability: Soldering time:3 ±0.5 Sec. So Solder Wetting: 95% of immer	C/Minute. M ohm min. +85°C ess: 0.8~1.6mm alue/10 m ohm max. vironmental '20 m ohm max. older temperature:245 ±5 esed area must show no		lated A
Resistance to Soldering He	eat: perature: 260°C±5°C 0.5m Pales Part No.	im from Terminal tip and fitting not be a second se	PCB LAYOUT
15	KI 2 2001 - WS - 02 - LF 0.0	72(12.0) 0.630(16.0) 551(14.0) 0.709(18.0) 30(16.0) 0.787(20.0) 709(18.0) 0.886(22.0) 87(20.0) 0.945(24.0) 86(22.0) 1.024(26.0) 45(24.0) 1.102(28.0)	B±0.3
極 數 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 K點示意圖	1 14 2001-WS-14-LF 1.0 15 2001-WS-15-LF 1.1 16 2001-WS-16-LF 1.1	02(28.0) 1.260(32.0) 81(30.0) 1.338(34.0)	2.0±0.10 A±0.2 AANCE: D
C B A REV Date FILE	JECSON BY	UNIT: SCALE: SHEET: PROJECTION:	DESCRIPTION: PART NO: F27-xxP